# \$16MD01/\$16MD02 \$26MD01/\$26MD02

# 8-Pin DIP Type SSR for Low Power Control

#### **■** Features

- 1. Compact 8-pin dual-in-line package type
- 2. RMS ON-state current  $I_T$ : 0.6Arms
- 3. Built-in zero-cross circuit

#### (S16MD02/S26MD02)

4. High repetitive peak OFF-state voltage

**\$16MD01 / \$16MD02**  $V_{DRM}$ : MIN. 400V **\$26MD01 / \$26MD02**  $V_{DRM}$ : MIN. 600V

- 5. Isolation voltage between input and output (  $V_{\rm iso}$ : 4,000Vrms )
- 6. Recognized by UL, file No. E94758
- 7. Approved by CSA No. LR63705

#### ■ Applications

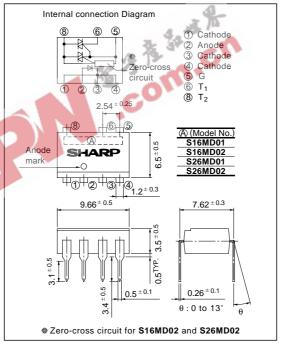
- 1. Oil fan heaters
- 2. Microwave ovens
- 3. Refrigerators

#### **■ Model Line-ups**

|                                    | For 100V lines | For 200V lines |
|------------------------------------|----------------|----------------|
| No built-in zero-<br>cross circuit | S16MD01        | S26MD01        |
| Built-in zero-<br>cross circuit    | S16MD02        | S26MD02        |
|                                    |                |                |

#### **■** Outline Dimensions

(Unit: mm)



Terminal 1, 3 and 4 are common ones of cathode. To radiate the heat, solder all of the lead pins on the pattern of PWB.

# ■ Absolute Maximum Ratings

 $(Ta = 25 \degree C)$ 

| Parameter               |                                |                 | Symbol Rating    |                    | Unit  |  |
|-------------------------|--------------------------------|-----------------|------------------|--------------------|-------|--|
| Input                   | Forward current                |                 | $I_F$            | 50                 | mA    |  |
|                         | Reverse voltage                |                 | V <sub>R</sub>   | 6                  | V     |  |
| Output                  | RMS ON-state current           |                 | $I_T$            | I <sub>T</sub> 0.6 |       |  |
|                         | *1Peak one cycle surge current |                 | I surge          | 6                  | A     |  |
|                         | Repetitive peak OFF-           | S16MD01/S16MD02 | 3.7              | 400                | V     |  |
|                         | state voltage                  | S26MD01/S26MD02 | V <sub>DRM</sub> | 600                | V     |  |
| *2 Isolation voltage    |                                |                 | V iso            | 4 000              | V rms |  |
| Operating temperature   |                                | T opr           | - 25 to + 80     | °C                 |       |  |
| Storage temperature     |                                | T stg           | - 40 to + 125    | °C                 |       |  |
| *3Soldering temperature |                                | T sol           | 260              | °C                 |       |  |

<sup>\*1 50</sup>Hz sine wave

<sup>\*2</sup> AC for 1 minute, 40 to 60% RH, f = 60Hz

<sup>\*3</sup> For 10 seconds

# **■** Electrical Characteristics

 $(Ta = 25^{\circ}C)$ 

|                          |                                                       |                    |                                 | T                                        | _                    |           |       |       |
|--------------------------|-------------------------------------------------------|--------------------|---------------------------------|------------------------------------------|----------------------|-----------|-------|-------|
| Parameter                |                                                       | Symbol             | Conditions                      | MIN.                                     | TYP.                 | MAX.      | Unit  |       |
| Input                    | Forward voltage                                       |                    | VF                              | $I_F = 20mA$                             | -                    | 1.2       | 1.4   | V     |
|                          | Reverse current                                       |                    | $I_R$                           | $V_R = 3V$                               | -                    | -         | 10    | μΑ    |
| Output                   | Repetitive peak OFF-state                             | e current          | $I_{DRM}$                       | $V_{DRM} = Rated$                        | -                    | -         | 100   | μΑ    |
|                          | ON-state voltage                                      |                    | V <sub>T</sub>                  | $I_T = 0.6A$                             | -                    | -         | 3.0   | V     |
|                          | Holding current                                       |                    | I <sub>H</sub>                  | $V_D = 6V$                               | -                    | -         | 25    | mA    |
|                          | Critical rate of rise of OFF-state                    | voltage            | dV/dt                           | $V_{DRM} = (1/\sqrt{2}) \cdot Rated$     | 100                  | 3.3       | 3 /14 | V/μ s |
|                          | Zero-cross voltage                                    | S16MD02<br>S26MD02 | Vox                             | Resistance load<br>I <sub>F</sub> = 15mA | 23                   | \$ 3ª     | 35    | V     |
| Transfer characteristics | Minimum trigger curre                                 | nt                 | I <sub>FT</sub>                 | $V_D = 6V$ , $R_L = 100 \Omega$          | X 4                  | -an       | 10    | mA    |
|                          | Isolation resistance                                  |                    | R iso                           | DC500V, 40 to 60 % RH                    | 5 x 10 <sup>10</sup> | $10^{11}$ | -     | Ω     |
|                          | Turn-on time S16MD01<br>S26MD01<br>S16MD02<br>S26MD02 |                    | $V_D = 6V$ , $R_L = 100 \Omega$ | C                                        | -                    | 100       | μs    |       |
|                          |                                                       |                    | t <sub>on</sub>                 | $I_F = 20 mA$                            | -                    | -         | 50    | μs    |

Fig. 1 RMS ON-state Current vs.
Ambient Temperature

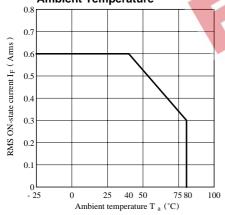


Fig. 3 Forward Current vs. Forward Voltage

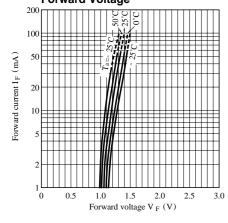


Fig. 2 Forward Current vs.

Ambient Temperature

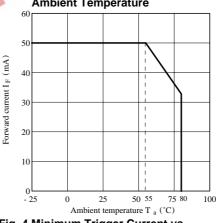


Fig. 4 Minimum Trigger Current vs. Ambient Temperature (S16MD01/S16MD02)

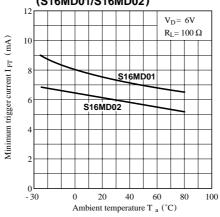


Fig. 5 Minimum Trigger Current vs.
Ambient Temperature
(S26MD01/ S26MD02)

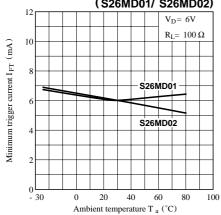


Fig. 7 Relative Holding Current vs.
Ambient Temperature

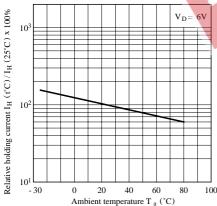


Fig. 9 Turn-on Time vs. Forward Current (S16MD01)

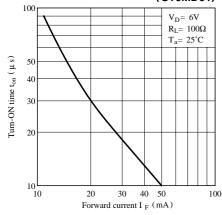


Fig. 6 ON-state Voltage vs.
Ambient Temperature

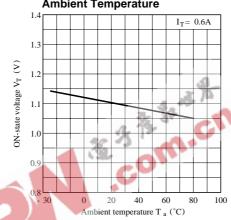


Fig. 8 ON-state Current vs. ON-state Voltage

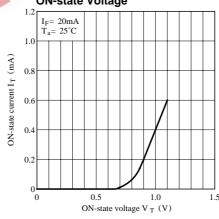


Fig.10 Turn-on Time vs. Forward Current (S26MD01)

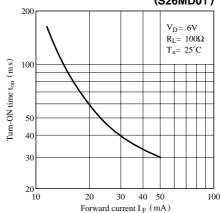


Fig.11 Turn-on Time vs. Forward Current (\$16MD02/\$26MD02)

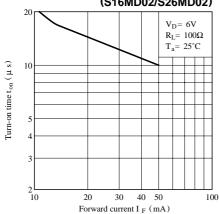
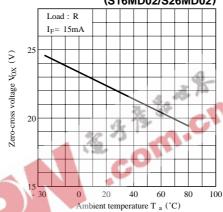
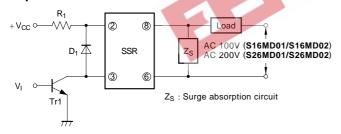
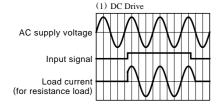


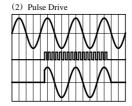
Fig.12 Zero-cross Voltage vs. Ambient Temperature (S16MD02/S26MD02)

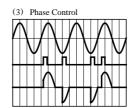


# **■** Basic Operation Circuit









Notes 1 ) If large amount of surge is loaded onto V  $_{\rm CC}$  or the driver circuit, add a diode D  $_{\rm I}$  between terminal 2 and 3 to prevent reverse bias from being applied to the infrared LED.

- 2 ) Be sure to install a surge absorption circuit.

  An appropriate circuit must be chosen according to the load (for CR, choose its constant). This must be carefully done especially for an inductive load.
- 3 ) For phase control, adjust such that the load current immediately after the input signal is applied will be more than 30mA.

### **■** Precautions for Use

- 1) All pins must be soldered since they are also used as heat sinks (heat radiation fins). In designing, consider the heat radiation from the mounted SSR.
- 2) For higher radiation efficiency that allows wider thermal margin, secure a wider round pattern for Pin No.8 when designing mounting pattern. The rounded part of Pin No.5 (gate) must be as small as possible. Pulling the gate pattern around increases the change of being affected by external noise.
- 3) As for other general cautions, refer to the chapter "Precautions for Use"